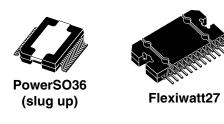


TDA7575B

2 x 75W multifunction dual-bridge power amplifier with integrated digital diagnostics

Features

- Multipower bcd technology
- MOSFET output power stage
- DMOS power output
- New high-efficiency (class AB)
- Single-channel 1Ω driving capability
- High output power capability 2x28 W/4 Ω @ 14.4 V, 1 kHz, 10 % THD
- Max. output power 2x75 W/2 Ω , 1x150 W/1 Ω
- Single-channel 1 Ω driving capability
- 84 W undistorted power
- Full I²C bus driving with 4 address possibilities:
 - Standby
 - Play/mute
 - Gain 12/26 dB
 - Full digital diagnostic (AC and DC loads)
- Possibility to disable the I²C bus
- Differential inputs
- Full fault protection
- DC offset detection
- Two independent short circuit protections
- Diagnostic on clipping detector with selectable threshold (2 % / 10 %)
- Clipping detector as diagnostic pin when I²C bus is disabled
- Standby/mute pins
- ESD protection



Description

The TDA7575B is a new MOSFET dual bridge amplifier specially intended for car radio applications. Thanks to the DMOS output stage the TDA7575B has a very low distortion allowing a clear powerful sound.

Among the features, its superior efficiency performance coming from the internal exclusive structure, makes it the most suitable device to simplify the thermal management in high power sets. The dissipated output power under average listening condition is in fact reduced up to 50% when compared to the level provided by conventional class AB solutions.

This device is equipped with a full diagnostic array that communicates the status of each speaker through the I 2 C bus. The TDA7575B has also the possibility of driving loads down to 1 Ω paralleling the outputs into a single channel. It is also possible to disable the I 2 C and control the TDA7575B by means of the usual standby and mute pins.

Table 1. Device summary

| Order code | Package | Packing |
|--------------|---------------------|---------------|
| TDA7575B | Flexiwatt27 | Tube |
| TDA7575BPD | PowerSO36 (slug up) | Tube |
| TDA7575BPDTR | PowerSO36 (slug up) | Tape and reel |

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1 Block and pins diagrams

Figure 1. Block diagram

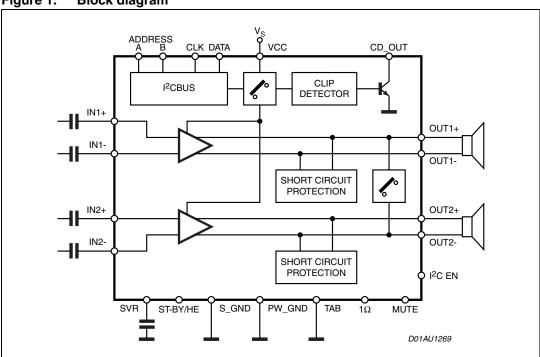
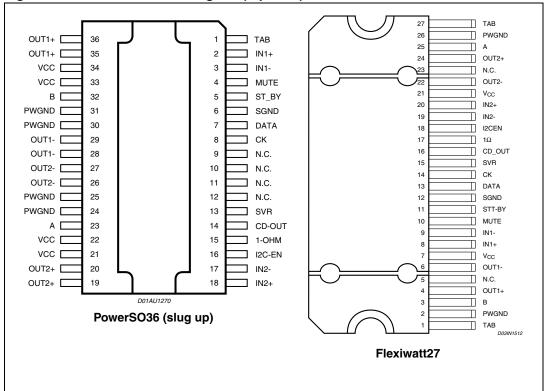


Figure 2. Pins connection diagram (top view)



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2 Electrical specifications

2.1 Absolute maximum ratings

Table 2. Absolute maximum ratings

| Symbol | Parameter | Value | Unit |
|-----------------------------------|---|------------|------|
| V _{op} | Operating supply voltage | 18 | V |
| V _S | DC supply voltage | 28 | V |
| V _{peak} | Peak supply voltage (for t = 50 ms) | 50 | V |
| V _{CK} | CK pin voltage | 6 | V |
| V _{DATA} | Data pin voltage | 6 | V |
| Io | Output peak current (not repetitive t = 100 ms) | 8 | Α |
| Io | Output peak current (repetitive f > 10 Hz) | 6 | Α |
| P _{tot} | Power dissipation T _{case} = 70 °C | 86 | W |
| T _{stg} , T _j | Storage and junction temperature | -55 to 150 | °C |

2.2 Thermal data

Table 3. Thermal data

| Symbol | Symbol Parameter | | Flexiwatt 27 | Unit |
|------------------------|---|---|--------------|------|
| R _{th j-case} | Thermal resistance junction-to-case Max | 1 | 1 | °C/W |

2.3 Electrical characteristics

 V_S = 14.4 V; f = 1 kHz; R_L = 4 Ω ; T_{amb} = 25 °C unless otherwise specified.

Table 4. Electrical characteristics

| Symbol | Parameter | Test condition | Min. | Тур. | Max. | Unit |
|----------------|-------------------------------|---|----------|----------------|------|------|
| Power an | Power amplifier | | | | | |
| V _S | Supply voltage range | - | 8 | - | 18 | V |
| I _d | Total quiescent drain current | - | 50 | 130 | 200 | mA |
| | | Max. power ⁽¹⁾ | 35 | 40 | - | W |
| Po | Output power | THD = 10 % THD = 1 %; BTL mode | 25 | 28 22 | - | W |
| P ₀ | | $R_L = 2 \Omega$; THD 10 % $R_L = 2 \Omega$; THD 1 % $R_L = 2 \Omega$; Max. power ⁽¹⁾ | 45 70 | 50 37 75 | - | W |

Table 4. Electrical characteristics (continued)

| Symbol | Parameter | Test condition | Min. | Тур. | Max. | Unit |
|------------------|---|--|-----------|---------------------|------------|------|
| P _o | Output power | Single channel configuration (1 Ω pin > 2.5 V); R _L = 1 Ω ; THD 3 % Max. power ⁽¹⁾ | 80 140 | 84 150 | - | W |
| | | P_0 = 1-12 W; STD mode HE mode; P_0 = 1-2 W HE mode; P_0 = 4-8 W | - | 0.03 0.03 0.5 | 0.1 0.1 | % |
| THD | Total harmonic distortion | P _o = 1-12 W, f = 10 kHz | - | 0.15 | 0.5 | % |
| IIID | THE TOTAL HAITHOUSE DISTURBLE | R _L = 2; HE mode; P _o = 3 W | - | 0.03 | 0.5 | % |
| | | Single channel configuration (1 Ω pin > 2.5 V); R _L = 1; P _o = 4-30 W | - | 0.02 | 0.1 | % |
| C _T | Cross talk | $R_g = 600 \Omega; P_o = 1 W$ | 60 | 75 | - | dB |
| R _{IN} | Input impedance | - | 60 | 100 | 130 | kΩ |
| G _{V1} | Voltage gain 1 (default) | - | 25 | 26 | 27 | dB |
| ∆G _{V1} | Voltage gain match 1 | - | -1 | 0 | 1 | dB |
| G _{V2} | Voltage gain 2 | - | 11 | 12 | 13 | dB |
| ∆G _{V2} | Voltage gain match 2 | - | -1 | 0 | 1 | dB |
| E _{IN1} | Output noise voltage gain 1 | $R_g = 600 \ \Omega; \ G_v = 26 \ dB$ filter 20 to 22 kHz | - | 40 | 60 | μV |
| E _{IN2} | Output noise voltage gain 2 | $R_g = 600 \Omega$; $G_v = 12d B$ filter 20 to 22 kHz | - | 15 | 25 | μV |
| SVR | Supply voltage rejection | $f = 100 \text{ Hz to } 10 \text{ kHz}; V_r = 1 \text{ Vpk};$ $R_g = 600 \Omega$ | 50 | 60 | - | dB |
| BW | Power bandwidth | (-3 dB) | 100 | - | - | KHz |
| A _{SB} | Standby attenuation | - | 90 | 100 | - | dB |
| I _{SB} | Standby current consumption | $V_{st-by} = 0 V$ | - | 2 | 10 | μА |
| A _M | Mute attenuation | - | 80 | 90 | | dB |
| V _{OS} | Offset voltage | Mute and play | -45 | 0 | 45 | mV |
| V _{AM} | Min. supply mute threshold | - | 7 | 7.5 | 8 | V |
| CMRR | Input CMRR | $V_{CM} = 1 \text{ Vpk-pk}; R_g = 0 \Omega$ | 56 | 60 | | dB |
| V _{MC} | Maximum common mode input level | f = 1 kHz | - | - | 1 | Vrms |
| SR | Slew rate | - | 1.5 | 4 | - | V/µs |
| ΔV _{OS} | During mute on/off output offset voltage | ITU R-ARM weighted | -10 | - | +10 | mV |
| Av OS | During standby on/off output offset voltage | see Figure 23 | -10 | - | +10 | mV |



Table 4. Electrical characteristics (continued)

| Symbol | Parameter | Test condition | Min. | Тур. | Max. | Unit |
|------------------|--|---|------|------|------|------|
| T _{ON} | Turn on delay | D2 (IB1) 0 to 1 | - | 15 | 40 | ms |
| T _{OFF} | Turn off delay | D2 (IB1) 1 to 0 | - | 15 | 40 | ms |
| V_{OFF} | Standby pin for standby | - | 0 | - | 1.5 | V |
| V _{SB} | Standby pin for standard bridge | - | 3.5 | - | 5 | V |
| V_{HE} | Standby pin for high-efficiency | - | 7 | - | 18 | V |
| | Standby pin current | 1.5 < V _{st-by/HE} < 18 V | 7 | 160 | 200 | μΑ |
| I _O | Standby pin current | V _{st-by} < 1.5 V | -10 | 0 | 10 | μΑ |
| V _m | Mute pin voltage for mute mode | - | 0 | - | 1.5 | V |
| V_{m} | Mute pin voltage for play mode | - | 3.5 | - | 18 | V |
| I _m | Mute pin current (standby) | $V_{\text{mute}} = 0 \text{ V}, V_{\text{st-by}} < 1.5 \text{V}$ | -5 | 0 | 5 | μΑ |
| I _m | Mute pin current (operative) | 0 V < V _{mute} < 18 V, V _{st-by} > 3.5 V | - | 65 | 100 | μА |
| V _{I2C} | I ² C pin voltage for I ² C disabled | - | 0 | - | 1.5 | V |
| V _{I2C} | I ² C pin voltage for I ² C enabled | - | 2.5 | - | 18 | V |
| I ² C | I ² C pin current (standby) | $0V < I^2C EN < 18V, V_{stby} < 1.5V$ | -5 | 0 | 5 | μА |
| I ² C | I ² C pin current (operative) | I ² C EN <18V, V _{st-by} >3.5V | 7 | 11 | 15 | μА |
| $V_{1\Omega}$ | 1 Ω pin voltage for 2ch mode | - | 0 | - | 1.5 | V |
| V _{1Ω} | 1 Ω pin voltage for 1 Ω mode | - | 2.5 | - | 18 | V |
| $I_{1\Omega}$ | 1 Ω pin current (standby) | $0 \text{ V} < 1 \Omega < 18 \text{ V}, \text{ V}_{\text{s-tby}} < 1.5 \text{ V}$ | -5 | 0 | 5 | μА |
| $I_{1\Omega}$ | 1 Ω pin current (operative) | 1 Ω < 18 V, V _{st-by} > 3.5 V | 7 | 11 | 15 | μА |
| La | A : 11 | Low logic level | 0 | - | 1.5 | V |
| На | A pin voltage | High logic level | 2.5 | - | 18 | V |
| la | A pin current (standby) | 0V < A < 18V , V _{stby} < 1.5 V | -5 | 0 | 5 | μА |
| la | A pin current (operative) | A<18V, V _{st-by} > 3.5V | 7 | 11 | 15 | μА |
| Lb | D : # | Low logic level | 0 | - | 1.5 | V |
| Hb | B pin voltage | High logic level | 2.5 | - | 18 | V |
| lb | B pin current (standby) | 0 V < B < 18 V, V _{s-tby} < 1.5 V | -5 | 0 | 5 | μА |
| lb | B pin current (operative) | B < 18 V, V _{st-by} > 3.5 V | 7 | 11 | 15 | μА |
| T _W | Thermal warning | - | - | 150 | - | °C |
| T _{Pl} | Thermal protection intervention | - | - | 170 | - | °C |
| I _{CDH} | Clip pin high leakage current | CD off, 0 V < V _{CD} < 5.5 V | -15 | 0 | 15 | μА |
| I _{CDL} | Clip pin low sink current | CD on; V _{CD} < 300 mV | 1 | | | mA |
| | 0: 1. 17:12: | D0 (IB1) = 0 | 0.8 | 1.3 | 2.5 | % |
| CD | Clip detect THD level | D0 (IB1) = 1 | 5 | 10 | 15 | % |

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Table 4. Electrical characteristics (continued)

| Symbol | Parameter | Test condition | Min. | Тур. | Max. | Unit |
|-----------|--|--|----------------------|------|---------------------|------|
| Turn-on o | liagnostics (Power amplifier me | ode) | | | | |
| Pgnd | Short to GND det. (below this limit, the output is considered in short circuit to GND) | Power amplifier in standby condition | - | - | 1.2 | V |
| Pvs | Short to Vs det. (above this limit, the output is considered in short circuit to VS) | - | V _s -0.9 | - | - | V |
| Pnop | Normal operation thresholds.(within these limits, the output is considered without faults). | - | 1.8 | - | V _s -1.5 | V |
| Lsc | Shorted load det. | - | - | - | 0.5 | Ω |
| Lop | Open load det. | - | 130 | 1 | - | Ω |
| Lnop | Normal load det. | - | 1.5 | ı | 70 | Ω |
| Turn-on o | liagnostics (Line driver mode) | | | | | |
| Pgnd | Short to GND det. (below this limit, the output is considered in short circuit to GND) | | 1 | - | 1.2 | V |
| Pvs | Short to Vs det. (above this limit, the Output is considered in Short Circuit to VS) | | V _s -0.9 | - | - | V |
| Pnop | Normal operation thresholds.(within these limits, the output is considered without faults). | Power amplifier in standby | 1.8 | - | V _s -1.5 | V |
| Lsc | Shorted load det. | | - | - | 1.5 | Ω |
| Lop | Open load det. | | 400 | - | - | Ω |
| Lnop | Normal load det. | | 4.5 | - | 200 | Ω |
| Permane | nt diagnostics (Power amplifier | mode or line driver mode) | | | | |
| Pgnd | Short to GND det. (below this limit, the output is considered in short circuit to GND) | Power amplifier in Mute or Play condition, one or more short circuits protection activated | - | - | 1.2 | V |
| Pvs | Short to Vs det. (above this limit, the Output is considered in Short Circuit to VS) | - | V _s - 0.9 | - | - | V |
| Pnop | Normal operation thresholds.(Within these limits, the Output is considered without faults). | - | 1.8 | - | V _s -1.5 | V |
| Loo | Shorted load det | Pow. amp. mode | - | - | 0.5 | Ω |
| Lsc | Shorted load det. | Line driver mode | - | - | 1.5 | Ω |



Table 4. Electrical characteristics (continued)

| Symbol | Parameter | Test condition | Min. | Тур. | Max. | Unit |
|-------------------------|-------------------------------|--|------|------|------|------|
| V _O | Offset detection | Power amplifier in play condition AC input signals = 0 | ±1.5 | ±2 | ±2.5 | V |
| I _{NLH} | Normal load current detection | V _O < (V _S - 5)pk IB2 (D0) = 0 | 500 | - | - | mA |
| I _{NLL} | Normal load current detection | V _O < (V _S - 5)pk IB2 (D0) = 1 | 250 | - | - | mA |
| I _{OLH} | Open load current detection | $V_O < (V_S - 5)pk \ IB2 \ (D0) = 0$ | - | - | 250 | mA |
| I _{OLL} | Open load current detection | V _O < (V _S - 5)pk IB2 (D0) =1 | - | - | 125 | mA |
| I ² C bus in | nterface | | | | | |
| f _{SCL} | Clock frequency | - | - | - | 400 | kHz |
| V _{IL} | Input low voltage | - | - | - | 1.5 | V |
| V _{IH} | Input high voltage | - | 2.3 | - | - | V |

^{1.} Saturated sqare wave output.

3 Electrical characteristics curves

Figure 3. Quiescent drain current vs. supply Figure 4. Output power vs. supply voltage voltage

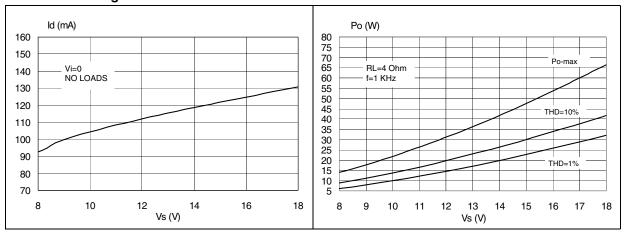


Figure 5. Output power vs. supply voltage

Figure 6. Output power vs. supply voltage

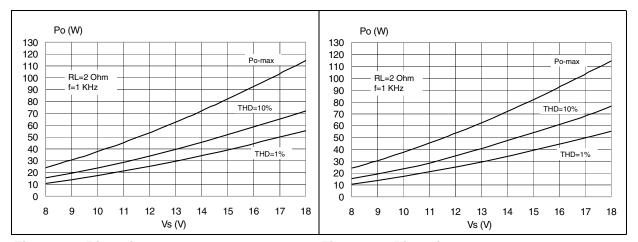
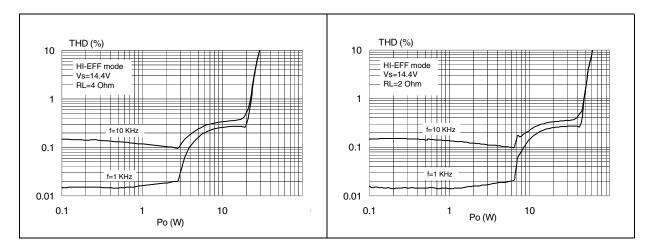


Figure 7. Distortion vs. output power

Figure 8. Distortion vs. output power



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Figure 9. Distortion vs. output power

Figure 10. Distortion vs. output power

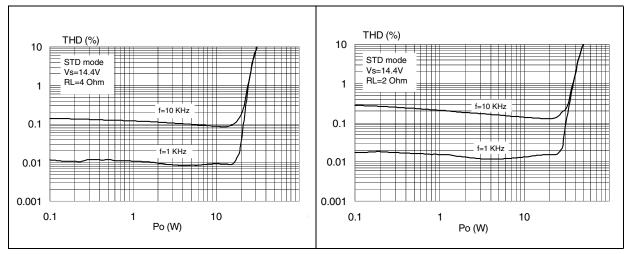


Figure 11. Distortion vs. output power

Figure 12. Distortion vs. frequency

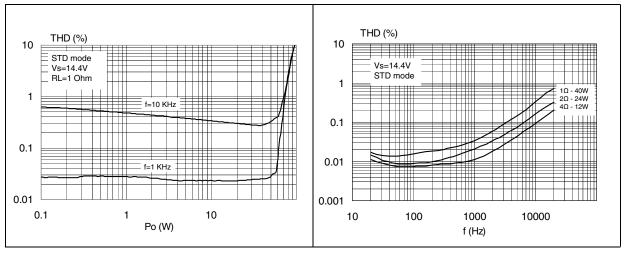


Figure 13. Distortion vs. output voltage (LD mode)

Figure 14. Cross talk vs. frequency

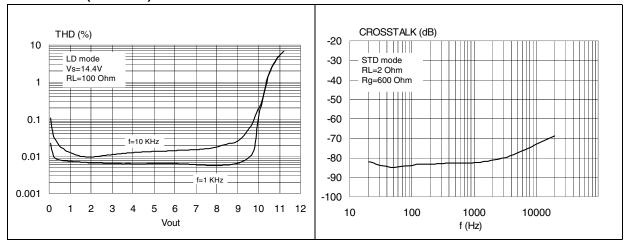
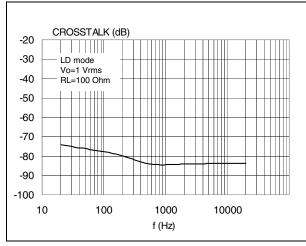


Figure 15. Cross talk vs. frequency (LD mode)

Figure 16. CMRRR vs. frequency



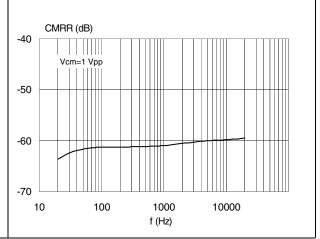
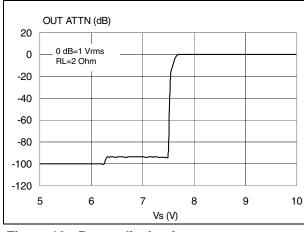
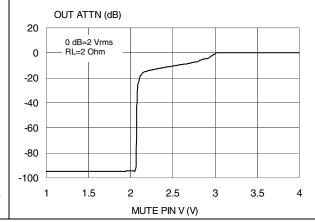


Figure 17. Output attenuation vs. supply voltage (vs. dependent muting)

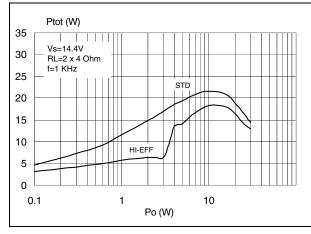
Figure 18. Output attenuation vs. mute pin voltage





(4 Ω - SINE)

Figure 19. Power dissipation vs. output power Figure 20. Power dissipation vs. output power (2 Ω - SINE)



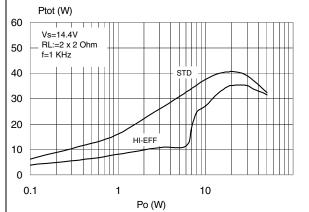
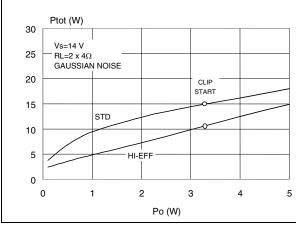


Figure 21. Power dissipation vs. average output power (Audio program simulation, 4Ω)

Figure 22. Power dissipation vs. average output power (Audio program simulation, 2Ω)



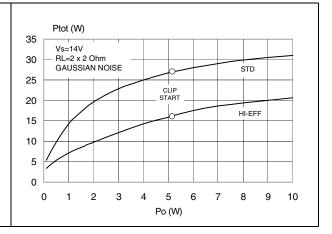
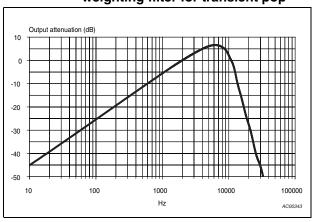


Figure 23. ITU R-ARM frequency response, weighting filter for transient pop



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TDA7575B Application circuits

4 Application circuits

Figure 24. Application circuit (TDA7575B)

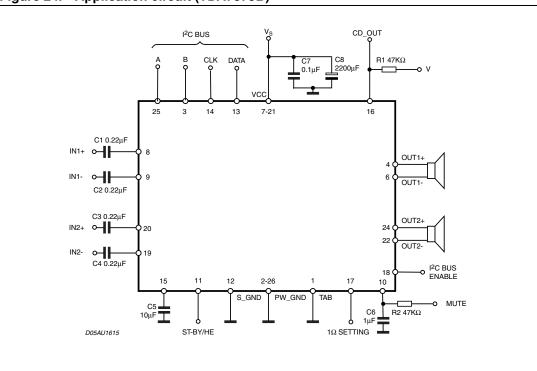
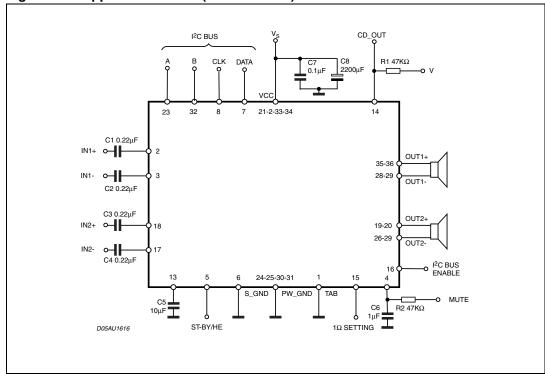


Figure 25. Application circuit (TDA7575BPD)



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I2C bus interface TDA7575B

5 I²C bus interface

Data transmission from microprocessor to the TDA7575B and vice versa takes place through the 2 wires I²C BUS interface, consisting of the two lines SDA and SCL (pull-up resistors to positive supply voltage must be connected).

5.1 Data validity

As shown by *Figure 26*, the data on the SDA line must be stable during the high period of the clock.

The high and low state of the data line can only change when the clock signal on the SCL line is low.

5.2 Start and stop conditions

As shown by *Figure 27* a start condition is a high to low transition of the SDA line while SCL is high.

The stop condition is A Low To High Transition of the SDA line while SCL is high.

5.3 Byte format

Every byte transferred to the SDA line must contain 8 bits. Each byte must be followed by an acknowledge bit. The MSB is transferred first.

5.4 Acknowledge

The transmitter^(*) puts a resistive HIGH level on the SDA line during the acknowledge clock pulse (see *Figure 28*). The receiver^(**) the acknowledges has to pull-down (LOW) the SDA line during the acknowledge clock pulse, so that the SDA line is stable LOW during this clock pulse.

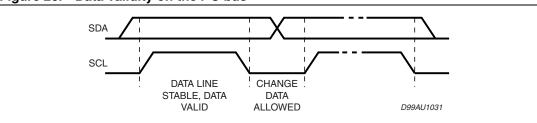
(*) Transmitter

- = master (μP) when it writes an address to the TDA7575B
- = slave (TDA7575B) when the μP reads a data byte from TDA7575B

(**) Receiver

- = slave (TDA7575B) when the μP writes an address to the TDA7575B
- = master (μ P) when it reads a data byte from TDA7575B

Figure 26. Data validity on the I²C bus



TDA7575B I2C bus interface

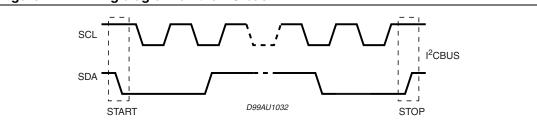
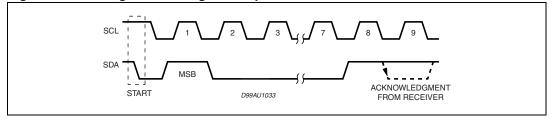


Figure 27. Timing diagram on the I²C bus

Figure 28. Timing acknowledge clock pulse



5.5 1 Ω capability setting

It is possible to drive 1Ω load paralleling the outputs into a single channel.

In order to implement this feature, outputs are to be connected on the board as follows:

- OUT1+ (pin 35 and pin 36) shorted to OUT2+ (pin 19 and pin 20)
- OUT1- (pin 28 and pin 29) shorted to OUT2- (pin 26 and pin 27).

It is recommended to minimize the impedance on the board between OUT2 and the load in order to minimize THD distortion. It is also recommended to control the maximum mismatch impedance between V_{CC} pins (pin 21/pin 22 respect to pin 33/pin 34) and between PWGND pins (pin 24/pin 25 respect to pin 30/pin 31), mismatch that must not exceed a value of 20 m Ω .

With 1 Ω feature settled the active input is IN2 (pin 17 and pin 18), therefore IN1 pins should be let floating.

It is possible to set the load capability acting on 1 Ω pin as follows:

1 Ω pin (pin 15) < 1.5 V: two channels mode (for a minimum load of 2 Ω)

1 Ω pin (pin 15) > 2.5 V: one channel mode (for 1 Ω load).

It is to remember that 1

Ohm function is a hardware selection.

Therefore it is recommended to leave 1Ω pin floating or shorted to GND to set the two channels mode configuration, or to short 1Ω pin to V_{CC} to set the one channel (1Ω) configuration.

I2C bus interface TDA7575B

5.6 I²C abilitation setting

It is possible to disable the I^2C interface by acting on I^2C pin (pin 16) and control the TDA7575B by means of the usual standby and mute pins. In order to activate or deactivate this feature, I^2C pin must be set as follows:

- I²C pin (pin 16) < 1.5V: I²C bus interface deactivated
- I²C pin (pin 16) > 2.5V: I²C bus interface activated

It is also possible to let I^2C pin floating to deactivate the I^2C bus interface, or to short I^2C pin to V_{CC} to activate it.

In particular:

- I²C enabled: I²C pin (pin 16) > 2.5 V
 - STD mode: V_{st-bv} (pin 5) > 3.5 V, IB2(D1)=0
 - HE mode: V_{st-by} (pin 5) > 3.5 V, IB2(D1)=1
 - Play mode: V_{mute} (pin 4) >3.5 V, IB1 (D2) = 1

The amplifier can always be switched off by putting $V_{st\text{-by}}$ to 0V , but with I^2C enabled it can be turn on only through I^2C (with $V_{st\text{-by}} > 3.5$ V).

- I^2C disabled: I^2C pin (pin 16) < 1.5 V
 - STD mode: 3.5V < standby (pin 5) < 5
 - HE mode: V_{stby} (pin 5) > 7 V
 - Play mode: V_{mute} (pin 4) > 3.5 V

For both STD and HE mode the play/mute mode can be set acting on V_{mute} pin.

When I^2C bus is disabled, when a fault is detected pin 14 (CD-OUT) is pulled down by the internal logic circuitry. The faults detected are the short circuit to ground, to V_{CC} and across the load (after an aver current detection).

6 Software specifications

All the functions of the TDA7575B are activated by I^2C interface.

The bit 0 of the "Address Byte" defines if the next bytes are write instruction (from μP to TDA7575B) or read instruction (from TDA7575B to μP).

Table 5. Address selection

| Bit | Address |
|-----|---------|
| A6 | 1 |
| A5 | 1 |
| A4 | 0 |
| А3 | 1 |
| A2 | 0 |
| A1 | В |
| A0 | A |
| R/W | X |

If R/W = 0, the μP sends 2 "instruction bytes": IB1 and IB2.

Table 6. IB1

| Bit | Instruction decoding bit |
|-----|---|
| D7 | 0 |
| D6 | Diagnostic enable (D6 = 1) Diagnostic defeat (D6 = 0) |
| D5 | Offset detection enable (D5 = 1) Offset detection defeat (D5 = 0) |
| D4 | Gain = 26 dB (D4 = 0) Gain = 12 dB (D4 = 1) |
| D3 | 0 |
| D2 | Mute (D2 = 0) Unmute (D2 = 1) |
| D1 | 0 |
| D0 | CD 2% (D0 = 0) CD 10% (D0 = 1) |

Table 7. IB2

| Bit | Instruction decoding bit |
|-----|--|
| D7 | 0 |
| D6 | 0 |
| D5 | 0 |
| D4 | Standby on - Amplifier not working - (D4 = 0) Standby off - Amplifier working - (D4 = 1) |
| D3 | Power amplifier mode diagnostic (D3 = 0); Line driver mode diagnostic (D3 = 1) |
| D2 | Current detection diagnostic enabled (D2 = 1) Current detection diagnostic defeat (D2 = 0) |
| D1 | Power amplifier working in standard mode (D1 = 0) Power amplifier working in high efficiency mode (D1 = 1) |
| D0 | Current detection threshold high (D7 =0) Current detection threshold low (D7 =1) |

If R/W = 1, the TDA7575B sends 2 "Diagnostics Bytes" to $\mu P \colon DB1$ and DB2.

Table 8. DB1

| Bit | Instruction | decoding bit |
|-----|--|---|
| D7 | Thermal warming (if Tchip ≥ 150°C, D7 = 1) | |
| D6 | Diag. cycle not activated or not terminated (D6 = 0) Diag. cycle terminated (D6 = 1) | |
| D5 | Channel 1 current detection IB2 (D0) = 0 Output peak current < 250 mA - Open load (D5 = 1) Output peak current > 500 mA - Normal load (D5 = 0) | Channel LF current detection IB2 (D0) = 1 Output peak current < 125 mA - Open load (D5 = 1) Output peak current > 250 mA - Normal load (D5 = 0) |
| D4 | Channel 1 Turn-on diagnostic (D4 = 0) Permanent diagnostic (D4 = 1) | |
| D3 | Channel 1 Normal load (D3 = 0) Short load (D3 = 1) | |
| D2 | Channel 1 Turn-on diag.: No open load (D2 = 0) Open load detection (D2 = 1) Offset diag.: No output offset (D2 = 0) Output offset detection (D2 = 1) | |
| D1 | Channel 1 No short to V_{cc} (D1 = 0) Short to V_{cc} (D1 = 1) | |
| D0 | Channel 1 No short to GND (D1 = 0) Short to GND (D1 = 1) | |



Table 9. DB2

| Bit | Instruction | decoding bit |
|-----|---|---|
| D7 | Offset detection not activated (D7 = 0) Offset detection activated (D7 = 1) | |
| D6 | Current sensor not activated (D6 = 0) Current sensor activated (D6 = 1) | |
| D5 | Channel LR Current detection IB2 (D0) = 0 Output peak current < 250 mA - Open load (D5 = 1) Output peak current > 500 mA - Normal load (D5 = 0) | Channel LR Current detection IB2 (D0) = 1 Output peak current < TBD mA - Open load (D5 = 1) Output peak current > TBD mA - Normal load (D5 = 0) |
| D4 | Channel 2 Turn-on diagnostic (D4 = 0) Permanent diagnostic (D4 = 1) | |
| D3 | Channel 2 Normal load (D3 = 0) Short load (D3 = 1) | |
| D2 | Channel 2 Turn-on diag.: No open load (D2 = 0) Open load detection (D2 = 1) Permanent diag.: No output offset (D2 = 0) Output offset detection (D2 = 1) | |
| D1 | Channel 2 No short to V_{cc} (D1 = 0) Short to V_{cc} (D1 = 1) | |
| D0 | Channel 2 No short to GND (D1 = 0) Short to GND (D1 = 1) | |

6.1 Examples of bytes sequence

1 - Turn-on diagnostic - Write operation

| Start Address byte with D0 = 0 | ACK | IB1 with D6 = 1 | ACK | IB2 | ACK | STOP |
|--------------------------------|-----|-----------------|-----|-----|-----|------|
|--------------------------------|-----|-----------------|-----|-----|-----|------|

2 - Turn-on diagnostic - Read operation

| - | | , | | | | | | |
|---|-------|--------------------------|-----|-----|-----|-----|-----|------|
| | Start | Address byte with D0 = 1 | ACK | DB1 | ACK | DB2 | ACK | STOP |

The delay from 1 to 2 can be selected by software, starting from T.B.D. ms

3a - Turn-on of the power amplifier with mute on, diagnostic defeat.

| Start | Address byte with D0 = 0 | ACK | IB1 | ACK | IB2 | ACK | STOP |
|-------|--------------------------|-----|----------|-----|----------|-----|------|
| | | | X000XXXX | | XXX1XX1X | | |

3b - Turn-off of the power amplifier

| Start | Address byte with D0 = 0 | ACK | IB1 | ACK | IB2 | ACK | STOP |
|-------|--------------------------|-----|----------|-----|----------|-----|------|
| | | | X0XXXXXX | | XXX0XXXX | | |

4 - Offset detection procedure enable

| Start | Address byte with D0 = 0 | ACK | IB1 | ACK | IB2 | ACK | STOP |
|-------|--------------------------|-----|----------|-----|----------|-----|------|
| | | | XX1XX1XX | | XXX1XXXX | | |

5 - Offset detection procedure stop and reading operation (the results are valid only for the offset detection bits (D2 of the bytes DB1, DB2, DB3, DB4).

| | ` , | , | , , | , | | | |
|-------|--------------------------|-----|-----|-----|-----|-----|------|
| Start | Address byte with D0 = 1 | ACK | DB1 | ACK | DB2 | ACK | STOP |

- The purpose of this test is to check if a D.C. offset (2 V typ.) is present on the outputs, produced by input capacitor with anomalous leakage current or humidity between pins.
- The delay from 4 to 5 can be selected by software, starting from T.B.D. ms

7 Diagnostics functional description

7.1 Turn-on diagnostic

It is activated at the turn-on (stand-by out) under I²C bus request. Detectable output faults are:

- Short to GND
- Short TO Vs
- Short across the speaker
- Open speaker

To verify if any of the above misconnections are in place, a subsonic (inaudible) current pulse ($Figure\ 29$) is internally generated, sent through the speaker(s) and sunk back. The Turn On diagnostic status is internally stored until a successive diagnostic pulse is requested (after a I^2C reading).

If the "stand-by out" and "diag. enable" commands are both given through a single programming step, the pulse takes place first (power stage still in stand-by mode, low, outputs = high impedance).

Afterwards, when the Amplifier is biased, the PERMANENT diagnostic takes place. The previous Turn On state is kept until a short appears at the outputs.

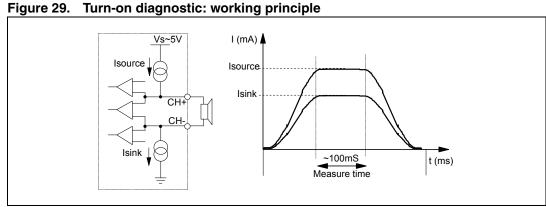
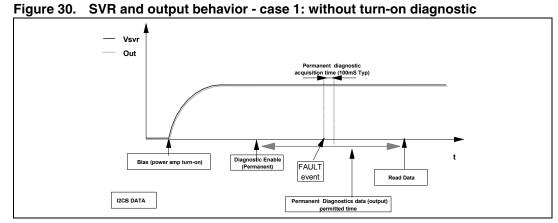


Fig. *Figure 30* and *Figure 31* show SVR and OUTPUT waveforms at the turn-on (stand-by out) with and without Turn-on diagnostic.



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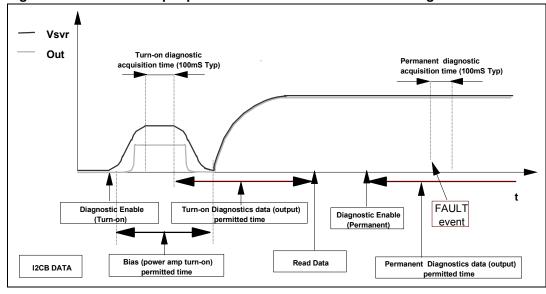
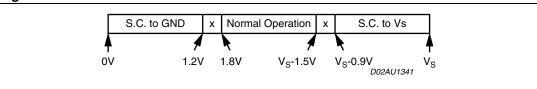


Figure 31. SVR and output pin behavior - case 2: with turn-on diagnostic

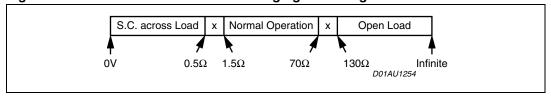
The information related to the outputs status is read and memorized at the end of the current pulse top. The acquisition time is 100 ms (typ.). No audible noise is generated in the process. As for short to GND / Vs the fault-detection thresholds remain unchanged from 26 dB to 12 dB gain setting. They are as follows:

Figure 32. Short circuit detection thresholds



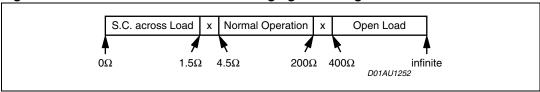
Concerning short across the speaker / open speaker, the threshold varies from 26 dB to 12 dB gain setting, since different loads are expected (either normal speaker's impedance or high impedance). The values in case of 26 dB gain are as follows:

Figure 33. Load detection thresholds - high gain setting



If the line-driver mode (Gv= 12 dB and line driver mode diagnostic = 1) is selected, the same thresholds will change as follows:

Figure 34. Load detection thresholds - high gain setting



7.2 Permanent diagnostics

Detectable conventional faults are:

- Short to GND
- Short to Vs
- Short across the speaker

The following additional features are provided:

Output offset detection

The TDA7575B has 2 operating statuses:

- RESTART mode. The diagnostic is not enabled. Each audio channel operates independently from each other. If any of the a.m. faults occurs, only the channel(s) interested is shut down. A check of the output status is made every 1 ms (fig. 30). Restart takes place when the overload is removed.
- 2. DIAGNOSTIC mode. It is enabled via I²C bus and self activates if an output overload (such to cause the intervention of the short-circuit protection) occurs to the speakers outputs. Once activated, the diagnostics procedure develops as follows (fig. 31):
 - To avoid momentary re-circulation spikes from giving erroneous diagnostics, a check of the output status is made after 1ms: if normal situation (no overloads) is detected, the diagnostic is not performed and the channel returns back active.
 - Instead, if an overload is detected during the check after 1 ms, then a diagnostic cycle having a duration of about 100 ms is started.
 - After a diagnostic cycle, the audio channel interested by the fault is switched to RESTART mode. The relevant data are stored inside the device and can be read by the microprocessor. When one cycle has terminated, the next one is activated by an I²C reading. This is to ensure continuous diagnostics throughout the carradio operating time.
 - To check the status of the device a sampling system is needed. The timing is chosen at microprocessor level (over than half a second is recommended).

Figure 35. Restart timing without diagnostic enable (permanent) each 1ms time, a sampling of the fault is done

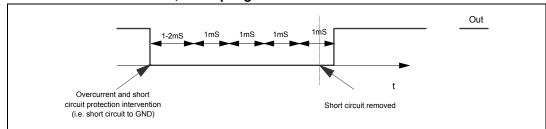
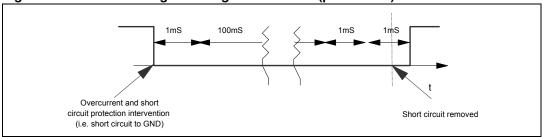


Figure 36. Restart timing with diagnostic enable (permanent)



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7.3 Output DC offset detection

Any DC output offset exceeding \pm 2 V are signalled out. This inconvenient might occur as a consequence of initially defective or aged and worn-out input capacitors feeding a DC component to the inputs, so putting the speakers at risk of overheating.

This diagnostic has to be performed with low-level output AC signal (or Vin = 0).

The test is run with selectable time duration by microprocessor (from a "start" to a "stop" command):

- Start = Last reading operation or setting IB1 D5 (OFFSET enable) to 1
- Stop = Actual reading operation

Excess offset is signalled out if persistent throughout the assigned testing time. This feature is disabled if any overloads leading to activation of the short-circuit protection occurs in the process.

7.4 AC diagnostic

It is targeted at detecting accidental disconnection of tweeters in 2-way speaker and, more in general, presence of capacitively (AC) coupled loads.

This diagnostic is based on the notion that the overall speaker's impedance (woofer + parallel tweeter) will tend to increase towards high frequencies if the tweeter gets disconnected, because the remaining speaker (woofer) would be out of its operating range (high impedance). The diagnostic decision is made according to peak output current thresholds, and it is enabled by setting (IB2-D2) = 1. Two different detection levels are available:

- High current threshold IB2 (D7) = 0
 - lout > 500 mApk = normal status
 - lout < 250 mApk = open tweeter
- Low current threshold IB2 (D7) = 1
 - lout > 250 mApk = normal status
 - lout < 125 mApk = open tweeter

To correctly implement this feature, it is necessary to briefly provide a signal tone (with the amplifier in "play") whose frequency and magnitude are such to determine an output current higher than 500mApk with IB2(D7)=0 (higher than 250mApk with IB2(D7)=1) in normal conditions and lower than 250 mApk with IB2(D7)=0 (lower than 125 mApk with IB2(D7)=1) should the parallel tweeter be missing.

The test has to last for a minimum number of 3 sine cycles starting from the activation of the AC diagnostic function IB2<D2>) up to the I²C reading of the results (measuring period). To confirm presence of tweeter, it is necessary to find at least 3 current pulses over the above threholds over all the measuring period, else an "open tweeter" message will be issued.

The frequency / magnitude setting of the test tone depends on the impedance characteristics of each specific speaker being used, with or without the tweeter connected (to be calculated case by case). High-frequency tones (> 10 kHz) or even ultrasonic signals are recommended for their negligible acoustic impact and also to maximize the impedance module's ratio between with tweeter-on and tweeter-off.

Figure 37 shows the load impedance as a function of the peak output voltage and the relevant diagnostic fields.

This feature is disabled if any overloads leading to activation of the short-circuit protection occurs in the process.

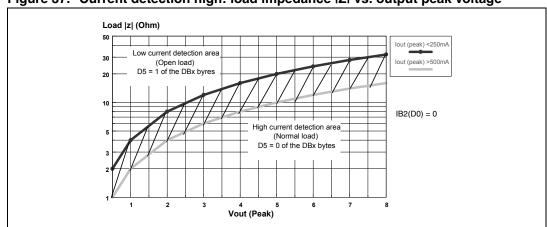
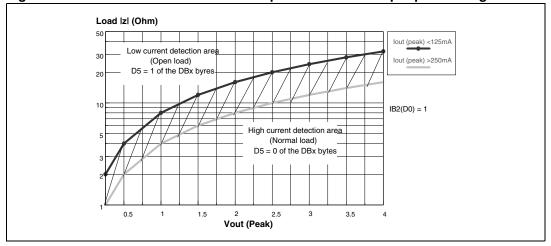


Figure 37. Current detection high: load impedance |Z| vs. output peak voltage





7.5 Multiple faults

When more misconnections are simultaneously in place at the audio outputs, it is guaranteed that at least one of them is initially read out. The others are notified after successive cycles of I²C reading and faults removal, provided that the diagnostic is enabled. This is true for both kinds of diagnostic (turn-on and permanent).

The table below shows all the couples of double-fault possible. It should be taken into account that a short circuit with the 4 Ω speaker unconnected is considered as double fault.

| | S. GND (sc) | S. GND (sk) | S. Vs | S. Across L. | Open L. |
|--------------|-------------|-------------|-------------------|--------------|-------------|
| S. GND (sc) | S. GND | S. GND | S. Vs + S. GND | S. GND | S. GND |
| S. GND (sk) | / | S. GND | S. Vs | S. GND | Open L. (*) |
| S. Vs | / | / | S. Vs | S. Vs | S. Vs |
| S. Across L. | / | / | / | S. Across L. | N.A. |
| Open L. | / | / | / | / | Open L. (*) |

Table 10. Double fault table for turn-on diagnostic

S. GND (so) / S. GND (sk) in the above table make a distinction according to which of the 2 outputs is shorted to ground (test-current source side= so, test-current sink side = sk). More precisely, in both the channels SO = CH+, and SK = CH-.

In permanent diagnostic the table is the same, with only a difference concerning open load (*), which is not among the recognizable faults. Should an open load be present during the device's normal working, it would be detected at a subsequent turn-on diagnostic cycle (i.e. at the successive car radio turn-on).

7.6 Faults availability

All the results coming from I^2C bus, by read operations, are the consequence of measurements inside a defined period of time. If the fault is stable throughout the whole period, it will be sent out. This is true for DC diagnostic (turn-on and permanent), for offset detector.

To guarantee always resident functions, every kind of diagnostic cycles (turn-on, permanent, offset) will be reactivate after any I^2C reading operation. So, when the micro reads the I^2C , a new cycle will be able to start, but the read data will come from the previous diag. cycle (i.e. The device is in turn-on state, with a short to GND, then the short is removed and micro reads I^2C . The short to GND is still present in bytes, because it is the result of the previous cycle. If another I^2C reading operation occurs, the bytes do not show the short). In general to observe a change in diagnostic bytes, two I^2C reading operations are necessary.

7.7 I²C programming/reading sequences

A correct turn on/off sequence respectful of the diagnostic timings and producing no audible noises could be as follows (after battery connection):

- Turn-on: (Standby OUT + DIAG enable) --- 500 ms (min) --- muting OUT
- Turn-off: Muting IN --- 20 ms --- (DIAG disable + standby IN)

Car radio installation: DIAG enable (write) --- 20 0ms --- I²C read (repeat until all faults disappear).

- Offset test: device in play (no signal)
- Offset enable 30 ms I²C reading

(repeat I²C reading until high-offset message disappears).

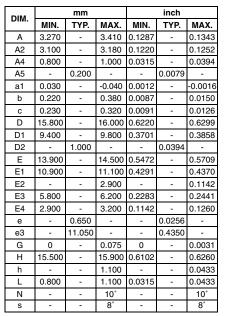
TDA7575B Package information

8 Package information

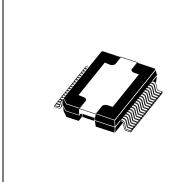
In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK[®] packages, depending on their level of environmental compliance. ECOPACK[®] specifications, grade definitions and product status are available at: *www.st.com*.

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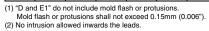
Figure 39. PowerSO36 (slug up) mechanical data and package dimensions

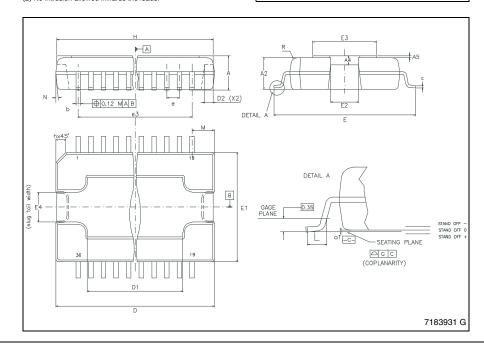


OUTLINE AND MECHANICAL DATA



PowerSO36 (SLUG UP)





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Package information TDA7575B

Figure 40. Flexiwatt27 (vertical) mechanical data and package dimensions

| DIM. | | mm | | | inch | | |
|----------|--|----------------|--|-------|---------|------------------|--------------------------|
| | MIN. | TYP. | MAX. | MIN. | TYP. | MAX. | OUTLINE AND |
| Α | 4.45 | 4.50 | 4.65 | 0.175 | 0.177 | 0.183 | OUTLINE AND |
| В | 1.80 | 1.90 | 2.00 | 0.070 | 0.074 | 0.079 | MECHANICAL DATA |
| С | | 1.40 | | | 0.055 | | |
| D | 0.75 | 0.90 | 1.05 | 0.029 | 0.035 | 0.041 | |
| E | 0.37 | 0.39 | 0.42 | 0.014 | 0.015 | 0.016 | |
| F (1) | | | 0.57 | | | 0.022 | |
| G | 0.80 | 1.00 | 1.20 | 0.031 | 0.040 | 0.047 | |
| G1 | 25.75 | 26.00 | 26.25 | 1.014 | 1.023 | 1.033 | |
| H (2) | 28.90 | 29.23 | 29.30 | 1.139 | 1.150 | 1.153 | |
| H1 | | 17.00 | | | 0.669 | | |
| H2 | | 12.80 | | | 0.503 | | |
| H3 | 00.07 | 0.80 22.47 | 00.07 | 0.000 | 0.031 | 0.004 | |
| L (2) | 22.07 | | 22.87 | 0.869 | 0.884 | 0.904 | |
| 2 (2) | 18.57 15.50 | 18.97 15.70 | 19.37 15.90 | 0.731 | 0.747 | 0.762 0.626 | |
| .2 (2) | 7.70 | 7.85 | | 0.810 | 0.618 | | |
| L3 L4 | 7.70 | | 7.95 | 0.303 | 0.309 | 0.313 | |
| L5 | - | 5 3.5 | - | | 0.197 | \vdash | |
| M | 3.70 | 4.00 | 4.30 | 0.145 | 0.138 | 0.169 | |
| M1 | 3.60 | 4.00 | 4.40 | 0.145 | 0.157 | 0.169 | |
| N | 0.00 | 2.20 | 7.40 | 0.142 | 0.137 | 0.175 | , w. |
| 0 | | 2.20 | | | 0.086 | \vdash | |
| R | | 1.70 | 1 | | 0.067 | \vdash | |
| R1 | | 0.5 | | | 0.02 | | |
| R2 | | 0.3 | | | 0.12 | | |
| R3 | | 1.25 | | | 0.049 | \vdash | |
| R4 | | 0.50 | | | 0.019 | | |
| V | 1 | | 5° (| Гур.) | | | Floring MOZ (continue) |
| V1 | | | 3° (| | | | Flexiwatt27 (vertical) |
| V2 | | | 20° (| | | | |
| V3 | | | | Typ.) | | | |
| 1): dam | -bar protu | sion not i | included | | | | |
| <u>c</u> | F1 B P P P P P P P P P P P P P P P P P P | V3 V3 | | Н3 | H H1 | <u>н</u> R3 、 | R L L1 V1 |
| | Pir | 1 | G | | G1 | | R2 R1 R1 R1 FLX27ME M M1 |



TDA7575B Revision history

9 Revision history

Table 11. Document revision history

| Date | Revision | Changes |
|-------------|----------|---|
| 30-Oct-2007 | 1 | Initial release. |
| 17-Dec-2009 | 2 | Updated Figure 39: PowerSO36 (slug up) mechanical data and package dimensions on page 29. |
| 17-Sep-2013 | 3 | Updated Disclaimer. |

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